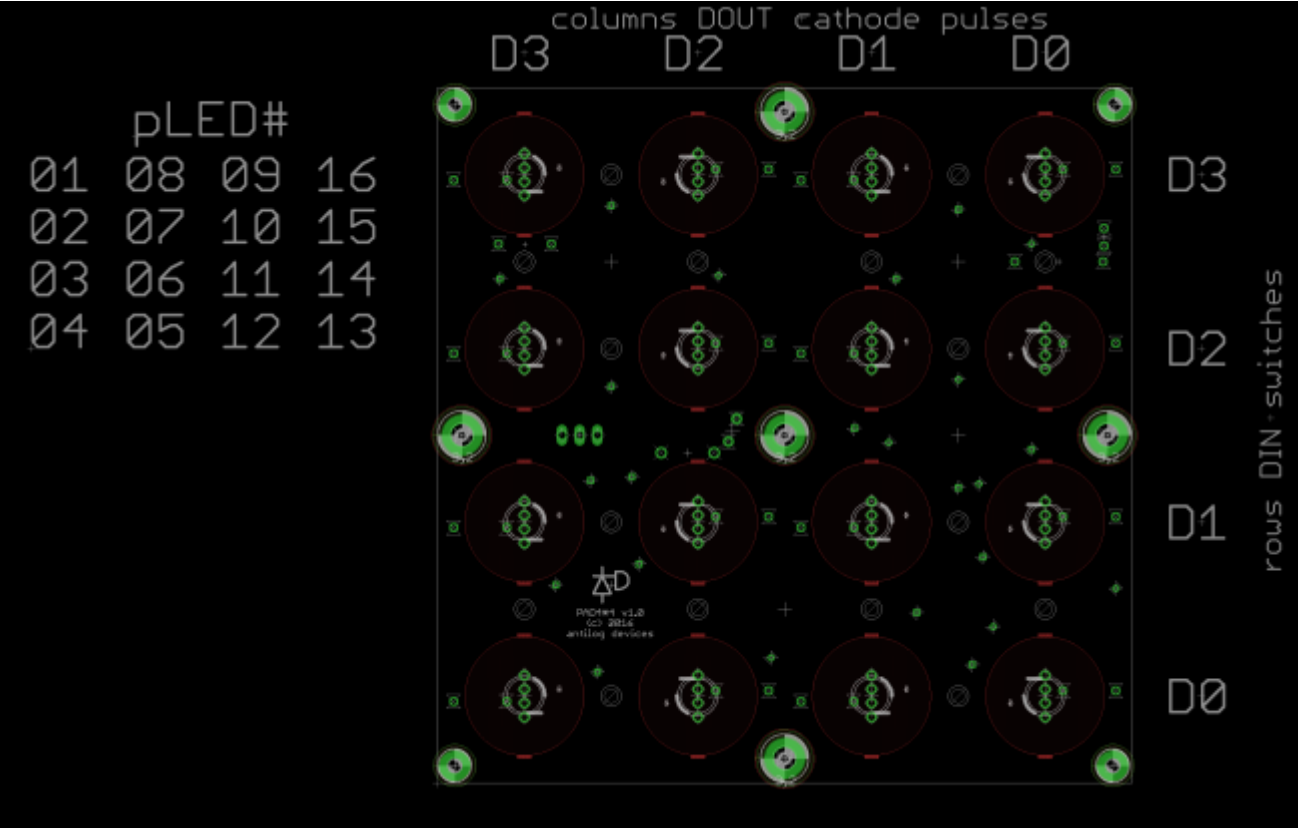


connected. The RC (R2, C18) end termination shouldn't be necessary, but can be trialled should problems with signal reflection arise.



Front view

Switches are connected in a 4*4 matrix with the given mapping. D0 refers to pin 10 of the IDC header (i.e. top right) for both DIN and DOUT.

BOM v1.1

Type	Qty	Value	Package	Parts	Notes
resistors					
	1	220-470R	0204/7	R1	replace with wire link for each additional module
capacitors					
	16	100n	1206	C2-17	
	1	100-1000u	electrolytic 3,5-6	C1	
diodes					
	1	1N5187	DO41-7.6	D1	
	16	1N4148	DO41-7.6	remaining axial diodes	
	16	WS2812B	5mm	programmable LEDs	
headers					
	4		2*5 (shrouded) SMT	J2-5	can use DIL 100mil breakaway header strips
	1		1X03_SMALL	J1	can use Molex 22-23-2031
switches					

Type	Qty	Value	Package	Parts	Notes
resistors					
	1		Sparkfun 4×4 pad		
misc					
	1		acrylic bezel		

Versions

v1.1: current release. Some traces moved around, grounding error fixed. J1 power header changed to offset pads so an SMT pinheader may be soldered if desired.

v1.0: errata: J4 and J5 have no connection to ground. J1-3 do carry ground, so it isn't a problem if the DIN/DOUT modules share the same power rail.

Assembly

In order to keep the button pad flat, it's best to solder all components on the rear of the board i.e. opposite the pads. The contacts are exposed ENIG, so try not to damage the surface by scratching or splashing solder/flux on them.

Start by tinning one pad (preferably not the pad joined to the ground plane with thermals) of each 1206 capacitor, making a “tack” joint, aligning the part and cleaning up if needed.

The best way to fix the 1N4148 diodes is to place the parts then solder **from the same side** only the anode lead on the inside of the button pad. Turn the board around and clip the cathode lead as close to the board as possible. You can even pull the lead out slightly. On the **rear** of the board, solder the cathode with as little solder as possible. The aim is to leave no solder bump on the frontside. Try to give equal care to the other through hole components (R1, C1, D1, J1).

If using shrouded headers, ensure the notch points on the same side as the pin 1 designator.

Interconnections

- J2 normally connects to Core J4B (I2C)
- J3 carries the WS2812B chain for additional modules
- J4 connects to a DIN header
- J5 connects to a DOUT header

License

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